

Certificate IATF 0601874
SGS Certificate number TW11/10513.01
The management system of

GlobalWafers Co., Ltd.

IATF USI: L2FAKK
No. 8, Industrial East Road 2, Hsinchu Science Park, Hsinchu City 300091, Taiwan, R.O.C.

has been assessed and certified as meeting the requirements of

IATF 16949:2016

Edition 1

For the following scope
Manufacture of silicon wafers and silicon polished wafers

EXCLUSIONS: 8.3 Product Design

3 Year certification is valid from 13 April 2026 until 12 April 2029 and remains valid subject to satisfactory surveillance audits.

Version no. 9. Current version updated 13 April 2026



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